L Number	Hits	Search Text	DB	Time stamp
4	8	("5437757" | "5707485" | "5805408" | "5830808" | "5920797" | "5922133" | "6117349" | "6200388").PN.	USPAT	2004/06/29 11:56
6	10	jp-05217951-$.did. or jp-07245292-$.did. or jp-07310187-$.did. or jp-10050665-$.did. or jp-09129612-$.did.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 12:02
7	60392	plasma and ring	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 12:08
9	1195	(plasma and ring) and (conductive near5 ring)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:46
11	255	((plasma and ring) and (conductive near5 ring)) and (insulating near5 ring)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:02
12	10	("4282924" | "5304278" | "5405491" | "5556500" | "5740009" | "5792304" | "5868848" | "5904778" | "6096161" | "6148765").PN.	USPAT	2004/06/29 12:15
13	2563	118/728.ccls. or 156/345.51.ccls.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:03
14	869	(118/728.ccls. or 156/345.51.ccls.) and ring	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:03
15	851	((118/728.ccls. or 156/345.51.ccls.) and ring) not (((plasma and ring) and (conductive near5 ring)) and (insulating near5 ring))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:04
16	8	("5437757" | "5707485" | "5805408" | "5830808" | "5920797" | "5922133" | "6117349" | "6200388").PN.	USPAT	2004/06/29 13:14
17	10	("5271788" | "5411624" | "5529657" | "5556500" | "5660673" | "5716486" | "5904799" | "6074488" | "6096161" | "6117349").PN.	USPAT	2004/06/29 13:17
18	2	6344105.URPN.	USPAT	2004/06/29 13:27
19	651	(chishio near koshimizu).in or (hiroyuki near ishihara).in. or (kimihiro near higuchi).in. or (koji near maruyama).in.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:48
21	81	((chishio near koshimizu).in or (hiroyuki near ishihara).in. or (kimihiro near higuchi).in. or (koji near maruyama).in.) and plasma	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:48
22	650	((chishio near koshimizu).in or (hiroyuki near ishihara).in. or (kimihiro near higuchi).in. or (koji near maruyama).in.) not ((118/728.ccls. or 156/345.51.ccls.) and ring)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:49
20	58	((chishio near koshimizu).in or (hiroyuki near ishihara).in. or (kimihiro near higuchi).in. or (koji near maruyama).in.) and ring	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/06/29 13:57

-	3159	118/724,725,728.ccls. or 156/345.51,345,52,345.53.ccls.	USPAT; US-PGPUB	2002/09/22 15:55
-	625	(118/724,725,728.ccls. or 156/345.51,345,52,345.53.ccls.) and temperature same (workpiece or wafer or semiconductor or object).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:00
-	247925	118/7$.ccls. or 156/345.$.ccls. or 204/$.ccls. or 315/$.ccls. 269/$.ccls. or 438/$.ccls. or 427/$.ccls.	USPAT; US-PGPUB	2002/09/22 15:57
-	26885	(118/7$.ccls. or 156/345.$.ccls. or 204/$.ccls. or 315/$.ccls. 269/$.ccls. or 438/$.ccls. or 427/$.ccls.) and (control or controller or controlling).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:16
-	3717	(118/7$.ccls. or 156/345.$.ccls. or 204/$.ccls. or 315/$.ccls. 269/$.ccls. or 438/$.ccls. or 427/$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:24
-	1636	((118/7$.ccls. or 156/345.$.ccls. or 204/$.ccls. or 315/$.ccls. 269/$.ccls. or 438/$.ccls. or 427/$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:00
-	119	(((118/7$.ccls. or 156/345.$.ccls. or 204/$.ccls. or 315/$.ccls. 269/$.ccls. or 438/$.ccls. or 427/$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) and (ring).ab,clm.	USPAT; US-PGPUB	2002/09/22 16:08
-	1517	(((118/7$.ccls. or 156/345.$.ccls. or 204/$.ccls. or 315/$.ccls. 269/$.ccls. or 438/$.ccls. or 427/$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) not ((((118/7$.ccls. or 156/345.$.ccls. or 204/$.ccls. or 315/$.ccls. 269/$.ccls. or 438/$.ccls. or 427/$.ccls.) and ((control or controller or controlling) same temperature).ab,clm.) and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) and (ring).ab,clm.)	USPAT; US-PGPUB	2002/09/22 16:09
-	0	269/390.ccls.	USPAT; US-PGPUB	2002/09/22 17:00
-	23247	269/$.ccls.	USPAT; US-PGPUB	2002/09/22 17:00
-	73	269/$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.	USPAT; US-PGPUB	2002/09/25 13:22
-	10	269/$.ccls. and (temperature same (ring)).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:12
-	689	269/$.ccls. and (ring).ab,clm.	USPAT; US-PGPUB	2004/06/29 12:07
-	229	269/$.ccls. and (temperature).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:13
-	141	(269/$.ccls. and (temperature).ab,clm.) not ((269/$.ccls. and (ring).ab,clm.) or (269/$.ccls. and (temperature same (ring)).ab,clm.) or (269/$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.))	USPAT; US-PGPUB	2002/09/22 17:16
-	986	269/$.ccls. and (control or controller or controlling).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:16
-	0	((269/$.ccls. and (temperature).ab,clm.) not ((269/$.ccls. and (ring).ab,clm.) or (269/$.ccls. and (temperature same (ring)).ab,clm.) or (269/$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.))) not ((269/$.ccls. and (temperature).ab,clm.) or (269/$.ccls. and (ring).ab,clm.) or (269/$.ccls. and (temperature same (ring)).ab,clm.) or (269/$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.))	USPAT; US-PGPUB	2002/09/22 17:17
-	831	(269/$.ccls. and (control or controller or controlling).ab,clm.) not ((269/$.ccls. and (temperature).ab,clm.) or (269/$.ccls. and (ring).ab,clm.) or (269/$.ccls. and (temperature same (ring)).ab,clm.) or (269/$.ccls. and (temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.))	USPAT; US-PGPUB	2002/09/22 17:18
-	43	269/$.ccls. and ((control or controller or controlling) same temperature).ab,clm.	USPAT; US-PGPUB	2002/09/22 17:24
-	122925	(temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.	JPO; DERWENT	2002/09/25 13:23

-	6880	((temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) and plasma	JPO; DERWENT	2002/09/25 13:28
-	6625	((temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) and plasma.ab,clm.	JPO; DERWENT	2002/09/25 13:28
-	3496	(((temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) and plasma.ab,clm.) and gas.ab,clm.	JPO; DERWENT	2002/09/25 13:29
-	552	((((temperature same (wafer or workpiece or substrate ot object or target)).ab,clm.) and plasma.ab,clm.) and gas.ab,clm.) and (control or controller or controlling).ab,clm.	JPO; DERWENT	2002/09/25 13:29
-	1101	118/728.ccls.	USPAT; US-PGPUB	2003/01/16 17:05
-	585	118/728.ccls. and ring	USPAT; US-PGPUB	2003/01/16 17:06
-	515	(118/728.ccls. and ring) and (heat ir heating or heated or heater or heating)	USPAT; US-PGPUB	2003/01/16 16:37
-	508	(118/728.ccls. and ring) and (heat or heating or heated or heater or heating)	USPAT; US-PGPUB	2003/01/16 17:34
-	2253	118/724,725.ccls.	USPAT; US-PGPUB	2003/01/16 17:06
-	914	118/724,725.ccls. and ring	USPAT; US-PGPUB	2003/01/16 17:33
-	8	("5437757" | "5707485" | "5805408" | "5830808" | "5920797" | "5922133" | "6117349" | "6200388").PN.	USPAT	2003/01/16 17:08
-	3284	156/345.$.ccls.	USPAT; US-PGPUB	2003/01/16 17:33
-	1424	156/345.$.ccls. and ring	USPAT; US-PGPUB	2003/01/16 17:34
-	949	(156/345.$.ccls. and ring) and (heat or heating or heated or heater or heating)	USPAT; US-PGPUB	2003/01/16 17:36
-	731	((156/345.$.ccls. and ring) and (heat or heating or heated or heater or heating)) not (((118/728.ccls. and ring) and (heat or heating or heated or heater or heating)) or (118/724,725.ccls. and ring))	USPAT; US-PGPUB	2003/01/16 18:02
-	143806	plasma	JPO; DERWENT	2003/01/16 18:02
-	5328	plasma and ring	JPO; DERWENT	2003/01/16 18:35
-	785	(plasma and ring) and (heat or heating or heater or heated)	JPO; DERWENT	2003/01/16 18:04
-	102	plasma and (focus adj ring)	JPO; DERWENT	2003/01/16 18:35
-	95	(plasma and (focus adj ring)) not ((plasma and ring) and (heat or heating or heater or heated))	JPO; DERWENT	2003/01/16 18:35